

Localized recrystallization and cracking of lead-free solder interconnections under thermal cycling – ERRATUM

Hongtao Chen, Maik Mueller, Toni Tuomas Mattila, Jue Li, Xuwen Liu, Klaus-Juergen Wolter, and Mervi Paulasto-Kröckel

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On the article opening page, the third author's name was incorrectly published as "Tonu Tuomas Mattila."

The correct spelling is **Toni Tuomas Mattila**.
The publisher regrets the error.

REFERENCE

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